



**CE**  
 High = Charge Enable

**PG**  
 ON = VCC Present

**STAT**  
 ON = CE high  
 OFF = Sleep mode  
 Blinking = CE low, Vin/Vout OV, Charge suspend

Title			
<b>TPS40210, BQ24640</b>			
Size	Number	Rev	
<b>C</b>	<b>PMP7327</b>	<b>B</b>	
Date	3/6/2012	Drawn by	J Betten
Filename	PMP7327 REVb_pads.sch	Sheet	1 of 1

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